AREA OF INTEREST

Papers in the following areas are invited by the symposium, but papers in other related areas will also be considered:

- Abrasive machining
- Abrasive jet machining
- Advanced cutting technology
- Beam processing and related topics
- CMP and semiconductor wafer processing
- Applications of abrasive technologies
- Eco-machining
- EDM and non-traditional machining
- Ultrasonic machining
- Finishing, lapping, polishing, and deburring
- Die, mold and related topics
- Grinding wheel and abrasive grain technologies
- High-speed and high-efficiency machining
- In-process measurement, monitoring, and metrology
- Machine tools and systems, tooling
- Additive manufacturing and related topics
- Micro/nano-machining
- Surface integrity and materials characterization
- Tribology in manufacturing
- Truing, dressing and ELID

IMPORTANT DATES

5.11		
March 1	Full paper submission to both IJAT and ISAAT	
May 1	Abstract submission to ISAAT	
May 31	Full paper submission to ISAAT	
June 30	Notification of ISAAT paper acceptance	
July 21	Submission of final ISAAT paper	
Aug. 4	Payment of early registration fee	
Nov. 30	Conference registration and reception	
Dec.1-2	Technical sessions	
Dec. 3	Technical visit	

SUBMISSION GUIDELINE

- Authors will be provided the options to submit their papers to ISAAT proceedings only, or to both ISAAT proceedings and the International Journal of Abrasive Technology (IJAT, EI indexed).
- Abstract submission to ISAAT: The abstract must include paper title, authors and their affiliations, and a summary of the paper within 200 words.
- Full ISAAT papers must be written in English of length from 4 to 6 proceedings pages. The version of the paper submitted to the IJAT has no limit on the number of pages.
- Each paper must be formatted and submitted according to the Instructions for Authors available in the conference website.

EXCELLENT PAPER

ISAAT Excellent Paper Awards will be selected for 10 presentations. Details will be available on the ICAT website.

PAPER PRESENTATION & PUBLICATION

All papers will be peer reviewed. Accepted papers MUST be presented in oral or poster session. Each delegate may present up to two papers (a publication fee will be charged for the second paper).

ACCOMMODATION

Information of hotel will be available on the conference website.

TRAVEL INFORMATION

Travel information will be available on the conference website.

SYMPOSIUM SECRETARIAT

Prof. Jun Shimizu Email: isaat2021@gmail.com

For conference details, updates and downloadable documents, visit the conference website at:

http://www.scoop-japan.com/kaigi/isaat2021/

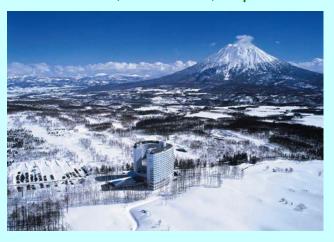


1st Circular

Call for Papers

ISAAT 2021

The 23rd International Symposium on Advances in Abrasive Technology 30 Nov. – 3 Dec. 2021
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ISAAT 2021

HISTORY & SCOPE

The International Symposium on Advances in Abrasive Technology (ISAAT) was first held in Sydney, Australia in 1997. Since 2002, JSAT and ICAT have been jointly organizing this exciting annual event for this community and the symposia have been successfully held in Hong Kong China, UK, Turkey, Russia, US, Japan, Australia, Taiwan China, Germany, Singapore, China, Republic of Korea, Sweden and Canada. An emphasis of the ISAAT series is to bring together both academic researchers and industrial practitioners from around the world for the interchange of the latest developments and applications in abrasive technologies. The ISAAT2021 in Niseko, Hokkaido, Japan will continue to promote the discipline development and research collaboration, and to foster the growth of young engineers and researchers in this field.

REGISTRATION

Full registration	JPY 70,000 (by Aug.4, 2021)
Student registration	JPY 50,000 (by Aug.4, 2021)
Late registration	JPY 80,000 (Full registration)
After Aug. 5, 2021	JPY 60,000 (Student registration)

A full registration and a student registration cover the costs for conference proceedings, welcoming reception, banquet, morning and afternoon refreshments, attendance to all the technical sessions, and lunches.

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*Depending on the global COVID'19 pandemic situation, the symposium may be switched to online platform. Thank you for your understanding.